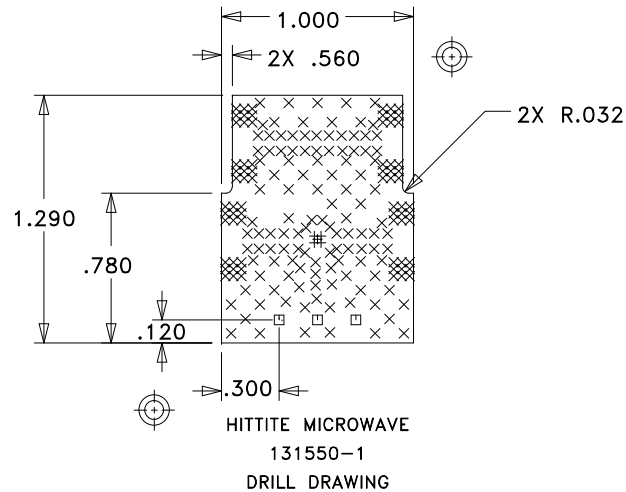


DO NOT SCALE PRINT

REVISION				
ZONE	LTR	DESCRIPTION	DATE	APPROVED
	1	ENGINEERING RELEASE	7/29/10	M. GIRDVAINIS



NOTES:  
UNLESS OTHERWISE SPECIFIED:

1. MATERIAL: MULTILAYER. OVERALL STACKUP AS SHOWN. TYPE ROGERS 4350 OR ARLON 25FR, HALF OUNCE COPPER BOTH SIDES. FR4 TO BE USED AS FILLER TO MEET CRITICAL OVERALL THICKNESS.
2. FINISH: GOLD PLATE PER ASTM B-488, TYPE III, CODE A, 8 TO 40 MICROINCHES, OVER NICKEL PER QQ-N-290, 100 MICROINCHES MINIMUM.
3. PLATED THRU HOLES: .001 MINIMUM WALL THICKNESS.
4. HOLE SIZES AND POSITIONS PER ARTWORK AND/OR DRILL FILE.
5. ALL HOLES TO BE LOCATED WITHIN  $\pm 0.003$  OF THE CENTER OF THE PAD OR OTHER TRUE POSITION.
6. FRONT TO BACK REGISTRATION  $\pm 0.003$  MAX.
7. BOARD WARPAGE:  $< .010$  PER LINEAR INCH.
8. SILKSCREEN TOP SIDE ONLY WITH WHITE EPOXY INK.
9. SOLDERMASK: LPI SOLDERMASK TOP SIDE. COLOR: GREEN REGISTRATION:  $\pm 0.004$  MAX.
10. "SIZE" IN DRILL LEGEND IS IN MILS AND REFERS TO FINISHED HOLE SIZE.
11. MANUFACTURE PER IPC-6012 CLASS 2.

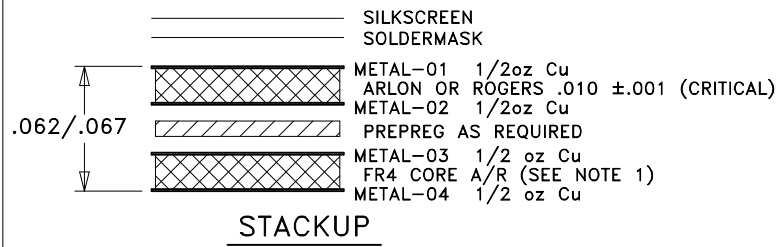
SPECIAL REQUIREMENTS:

12. CRITICAL LINE WIDTH =  $.016 \pm 0.001$  ON METAL-01. ADJUST PROCESS TO ACHIEVE WIDTH.

VENDOR NOTES:

13. VENDOR MAY ADD E-TEST STAMP TO PCB. VENDOR SHALL NOT ADD NAME, LOGO, DATE CODE, UL LISTING OR ANY OTHER MARKING TO ANY VISIBLE LAYER.
14. BOARDS MUST PASS VISUAL INSPECTION PER IPC-A-600 CLASS 2.

SIZE	QTY	SYM	PLATED	TOL
10	5	+	YES	$\pm .3$
14	189	X	YES	$\pm .3$
43	3	□	YES	$\pm .3$



PROPRIETARY TO HITTITE MICROWAVE CORPORATION

UNLESS OTHERWISE SPECIFIED:		DWN BY:	M. GIRDVAINIS	7/27/10
DIMENSIONS ARE IN INCHES (MM)		ENGINEER:	JEFF SCALF	
DRAWING PRACTICES PER ASME Y14.100 INTERPRET DIMENSIONS & TOLERANCES PER ASME Y14.5-2009				
TOLERANCES:				
.XX	$\pm .010$			
.XXX	$\pm .005$			
.XXXX	$\pm .002$			
ANGLES	$\pm .5$ DEG			



HITTITE MICROWAVE CORPORATION  
20 Alpha Road Chelmsford, MA 01824

TITLE  
PCB, EVAL  
HMC5439LP3E

SIZE	CODE ID NO.	DRAWING NO.	REV
A	1CN88	131550	1
SCALE:		WT	SHEET 1 of 1